

SLOVENSKI STANDARD SIST EN IEC 62769-7:2021

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Integracija procesne naprave (FDI) - 7. del: Komunikacijske naprave FDI (IEC 62769-7:2021)

Field Device Integration (FDI) - Part 7: Communication devices (IEC 62769-7:2021)

Feldgeräteintegration (FDI) - Teil 7: FDI-Kommunikationsgeräte (IEC 62769-7:2021)

Intégration des appareils de terrain (FDI) - Partie 7: Appareils de communication (IEC 62769-7:2021)

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EUROPEAN STANDARD
NORME EUROPÉENNE
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March 2021

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Supersedes EN 62769-7:2015 and all of its amendments
and corrigenda (if any)

English Version

**Field Device Integration (FDI) - Part 7: Communication devices
(IEC 62769-7:2021)**

Intégration des appareils de terrain (FDI) - Partie 7:
Appareils de communication
(IEC 62769-7:2021)

Feldgeräteintegration (FDI) - Teil 7: FDI-
Kommunikationsgeräte
(IEC 62769-7:2021)

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Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN IEC 62769-7:2021 (E)**European foreword**

The text of document 65E/764(F)/FDIS, future edition 2 of IEC 62769-7, prepared by SC 65E “Devices and integration in enterprise systems” of IEC/TC 65 “Industrial-process measurement, control and automation” was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62769-7:2021.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2021-12-12 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2024-03-12 document have to be withdrawn

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Annex ZA

(normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61804-3	-	Devices and integration in enterprise systems - Function blocks (FB) for process control and electronic device description language (EDDL) - Part 3: EDDL syntax and semantics	EN IEC 61804-3	-
IEC 61804-4	-	Devices and integration in enterprise systems - Function blocks (FB) for process control and electronic device description language (EDDL) - Part 4: EDDL interpretation	EN IEC 61804-4	-
IEC 62541	series	OPC Unified Architecture	EN IEC 62541	series
IEC 62769-1	-	Field Device Integration (FDI) - Part 1: Overview	EN IEC 62769-1	-
IEC 62769-2	-	Field Device Integration (FDI) - Part 2: FDI Client	EN IEC 62769-2	-
IEC 62769-3	-	Field Device Integration (FDI) - Part 3: Server	EN IEC 62769-3	-
IEC 62769-4	2021	Field Device Integration (FDI) - Part 4: FDI Packages	EN IEC 62769-4	2021
IEC 62769-5	-	Field Device Integration (FDI) - Part 5: Information Model	EN IEC 62769-5	-

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IEC 62769-7

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INTERNATIONAL STANDARD

NORME INTERNATIONALE



Field device integration (FDI) –
Part 7: Communication devices

Intégration des appareils de terrain (FDI) –
Partie 7: Appareils de communication

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CONTENTS

FOREWORD	6
INTRODUCTION	8
1 Scope	9
2 Normative references	10
3 Terms, definitions, abbreviated terms and conventions	10
3.1 Terms and definitions	10
3.2 Abbreviated terms	10
3.3 Conventions	11
4 General	11
5 FDI Communication Package	13
5.1 General	13
5.2 EDD	13
5.2.1 General rules	13
5.2.2 Device component	14
5.2.3 CommunicationDevice component	15
5.2.4 Communication service provider component	16
5.2.5 Connection Point component	17
5.2.6 Connection Point collection	18
5.2.7 Network component	18
5.2.8 ValidateNetwork	20
5.2.9 ValidateModules	20
5.2.10 UIP specifications	21
5.2.11 Deployment	21
6 Communication relations	21
7 FDI Communication Server definition	23
7.1 General	23
7.2 General characteristics	23
7.3 Information Model	23
7.3.1 General	23
7.3.2 CommunicationServerType	26
7.3.3 ServerCommunicationDeviceType	30
7.3.4 ServerCommunicationServiceType	33
7.4 OPC UA Server Profile for FDI Communication Server	37
7.5 Mapping the FDI Server IM to the FDI Communication Server IM	38
7.5.1 General	38
7.5.2 Information Model differences	38
7.6 Installer	39
7.7 FDI Communication Package	39
7.7.1 General	39
7.7.2 EDD for Lightweight Communication Server	40
7.7.3 EDD for Multi-Channel Communication Server	40
7.7.4 COMMANDs in EDDs for FDI Communication Servers	41
7.7.5 Documentation	41
7.8 Handling and behavior	41
7.8.1 General	41

7.8.2	Deployment	42
7.8.3	Server configuration	42
7.8.4	Start up	43
7.8.5	Shutdown	43
7.8.6	Watchdog	43
7.8.7	Establish the OPC UA connection	43
7.8.8	Instantiate the Communication Server	44
7.8.9	Configure the communication hardware	44
7.8.10	Configuring the Network	44
7.8.11	Parameterize	44
7.8.12	Initialize	44
7.8.13	Create the communication service object	45
7.8.14	Communication relation	45
7.8.15	Connect	45
7.8.16	Disconnect	46
7.8.17	Abort Indication	46
7.8.18	Scan	46
7.8.19	SetAddress	46
8	FDI Communication Gateway definition	46
8.1	General	46
8.2	Information Model	46
8.2.1	General	46
8.2.2	CommunicationGatewayType	47
8.2.3	GatewayCommunicationDeviceType	48
8.2.4	GatewayCommunicationServiceType	51
8.3	FDI Communication Package	55
8.3.1	General	55
8.3.2	EDD	56
8.4	Handling and behavior	57
8.4.1	General	57
8.4.2	Deployment	58
8.4.3	Start up	58
8.4.4	Configure the communication hardware	58
8.4.5	Configure the Network	58
8.4.6	Parameterize	58
8.4.7	Communication relation	59
8.4.8	Connect	59
8.4.9	Disconnect	59
8.4.10	Abort indication	59
8.4.11	Scan	59
8.4.12	Communication Error Handling	60
Annex A	(informative) Layered protocols	61
A.1	General	61
A.2	Convention for protocol-specific annex creation	61
A.3	FDI Communication Package definition	62
A.3.1	Communication services	62
A.3.2	Connection Point	62
A.3.3	Network	62
A.4	Representation in the IM	63

Annex B (normative) Namespace and mappings	64
Figure 1 – FDI architecture diagram	9
Figure 2 – FDI communication infrastructure architecture	12
Figure 3 – Communication relation	22
Figure 4 – Communication relation state chart	23
Figure 5 – FDI Communication Server AddressSpace	25
Figure 6 – CommunicationServerType	26
Figure 7 – ServerCommunicationDeviceType	30
Figure 8 – ServerCommunicationServiceType	34
Figure 9 – Information Model differences (example)	38
Figure 10 – FDI Communication Server state machine	42
Figure 11 – Communication relation state chart	45
Figure 12 – Gateway information model	47
Figure 13 – CommunicationGatewayType	48
Figure 14 – GatewayCommunicationDeviceType	49
Figure 15 – GatewayCommunicationServiceType	52
Figure 16 – Nested Communication	58
Table 1 – ValidateNetwork Action arguments	20
Table 2 – ValidateModules Action arguments	21
Table 3 – CommunicationServerType definition	26
Table 4 – MethodSet of CommunicationServerType	26
Table 5 – Reset Method arguments	27
Table 6 – Reset Method AddressSpace definition	27
Table 7 – Initialize Method arguments	28
Table 8 – Initialize Method AddressSpace definition	28
Table 9 – AddComponent Method arguments	29
Table 10 – AddComponent Method AddressSpace definition	29
Table 11 – RemoveComponent Method arguments	30
Table 12 – RemoveComponent Method AddressSpace definition	30
Table 13 – ServerCommunicationDeviceType definition	31
Table 14 – MethodSet of ServerCommunicationDeviceType	31
Table 15 – Scan Method arguments	32
Table 16 – Scan Method AddressSpace definition	32
Table 17 – ResetScan Method arguments	32
Table 18 – ResetScan Method AddressSpace definition	33
Table 19 – SetAddress Method arguments	33
Table 20 – ServerCommunicationServiceType definition	34
Table 21 – MethodSet of ServerCommunicationServiceType	34
Table 22 – Connect Method arguments	35
Table 23 – Disconnect Method arguments	36
Table 24 – Transfer Method arguments	36

Table 25 – GetPublishedData Method arguments.....	37
Table 26 – FDICommunicationServer_Facet definition	37
Table 27 – CommunicationGatewayType definition	48
Table 28 – GatewayCommunicationDeviceType definition.....	49
Table 29 – MethodSet of GatewayCommunicationDeviceType	49
Table 30 – Scan Method arguments	50
Table 31 – Scan Method AddressSpace definition.....	50
Table 32 – ScanNext Method arguments	51
Table 33 – ScanNext Method AddressSpace definition	51
Table 34 – GatewayCommunicationServiceType definition.....	52
Table 35 – MethodSet of GatewayCommunicationServiceType	53
Table 36 – Connect Method arguments	54
Table 37 – Transfer Method arguments.....	55

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIELD DEVICE INTEGRATION (FDI) –**Part 7: Communication devices****FOREWORD**

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International Standard IEC 62769-7 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This second edition cancels and replaces the first edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) support for generic protocol extension for faster adoption of other technologies;
- b) support of new protocols;
- c) generic protocol extension to allow adoption of other communication protocols;
- d) based on generic protocol extension: Modbus RTU.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
65E/764/FDIS	65E/774/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

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INTRODUCTION

The IEC 62769 series has the general title *Field Device Integration (FDI)* and the following parts:

- Part 1: Overview
- Part 2: FDI Client
- Part 3: FDI Server
- Part 4: FDI Packages
- Part 5: FDI Information Model
- Part 6: FDI Technology Mapping
- Part 7: FDI Communication Devices
- Part 100: Profiles – Generic Protocol Extensions
- Part 101-1: Profiles – Foundation Fieldbus H1
- Part 101-2: Profiles – Foundation Fieldbus HSE
- Part 103-1: Profiles – PROFIBUS
- Part 103-4: Profiles – PROFINET
- Part 109-1: Profiles – HART and WirelessHART
- Part 115-2: Profiles – Protocol-specific Definitions for Modbus RTU
- Part 150-1: Profiles – ISA 100.11a

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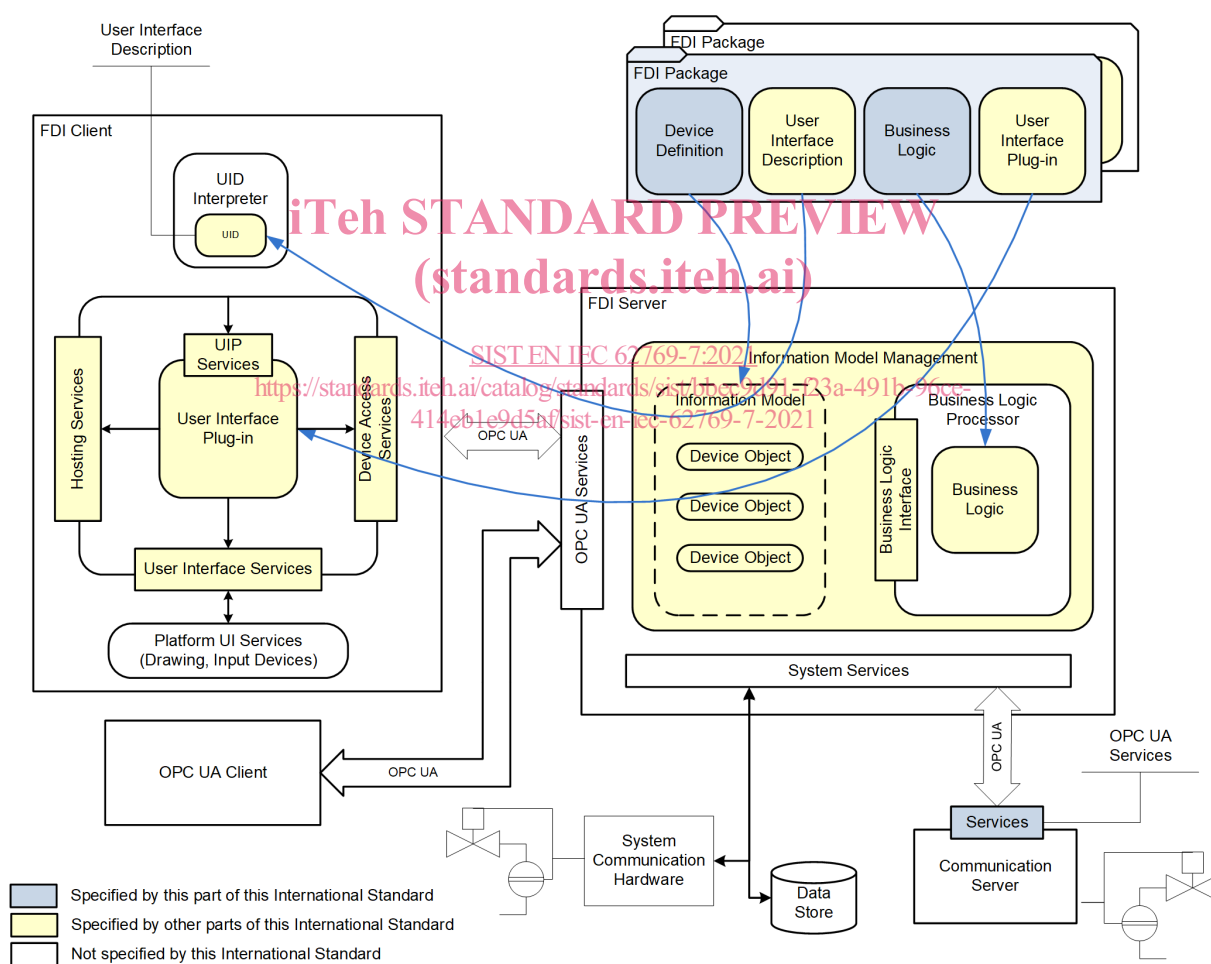
FIELD DEVICE INTEGRATION (FDI) –

Part 7: Communication devices

1 Scope

This part of IEC 62769 specifies the elements implementing communication capabilities called Communication Devices (IEC 62769-5).

The overall FDI architecture is illustrated in Figure 1. The architectural components that are within the scope of this document have been highlighted in this illustration. The document scope with respect to FDI Packages is limited to Communication Devices. The Communication Server shown in Figure 1 is an example of a specific Communication Device.



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Figure 1 – FDI architecture diagram